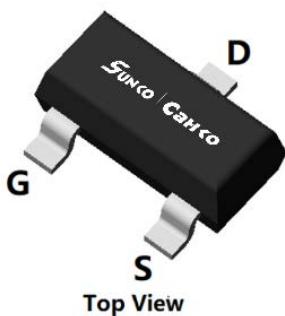
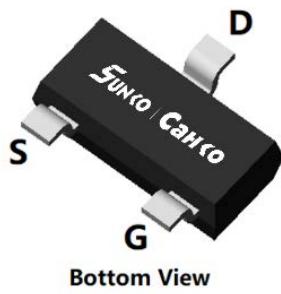


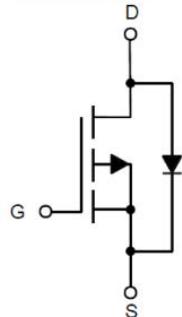
## P-Channel Enhancement Mode Field Effect Transistor



Top View



Bottom View

**SOT-23**

### Product Summary

- $V_{DS}$  -15V
- $I_D$  -5.6A
- $R_{DS(ON)}$  (at  $V_{GS}=-4.5V$ ) <34 mohm
- $R_{DS(ON)}$  (at  $V_{GS}=-2.5V$ ) <44 mohm
- $R_{DS(ON)}$  (at  $V_{GS}=-1.8V$ ) <62 mohm

### General Description

- Trench Power LV MOSFET technology
- High Density Cell Design for Low  $R_{DS(ON)}$
- High Speed switching
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

### Applications

- Battery protection
- Load switch
- Power management

### ■ Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter   | Symbol          | Limit    | Unit                      |
|---|-----------------|----------|---------------------------|
| Drain-source Voltage  | $V_{DS}$        | -15      | V                         |
| Gate-source Voltage   | $V_{GS}$        | $\pm 10$ | V                         |
| Drain Current<br><br>$T_A=25^\circ\text{C}$                   | $I_D$           | -5.6     | A                         |
| $T_A=70^\circ\text{C}$  |                 | -4.5     |                           |
| Pulsed Drain Current <sup>A</sup>                             | $I_{DM}$        | -23      | A                         |
| Total Power Dissipation @ $T_A=25^\circ\text{C}$ Steady State | $P_D$           | 1.2      | W                         |
| Thermal Resistance Junction-to-Ambient <sup>B</sup>           | $R_{\theta JA}$ | 105      | $^\circ\text{C}/\text{W}$ |
| Junction and Storage Temperature Range                        | $T_J, T_{STG}$  | -55~+150 | $^\circ\text{C}$          |

### ■ Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|---------|----------------------|-------------------------|----------------------------|---------------|
| SCL2305A      | F2           | 2305.   | 3000                 | 30000                   | 120000                     | 7" reel       |

■ Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Parameter                             | Symbol                   | Conditions  | Min  | Typ   | Max       | Units            |
|---------------------------------------|--------------------------|---|------|-------|-----------|------------------|
| <b>Static Parameter</b>               |                          |   |      |       |           |                  |
| Drain-Source Breakdown Voltage        | $\text{BV}_{\text{DSS}}$ | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$   | -15  |       |           | V                |
| Zero Gate Voltage Drain Current       | $I_{\text{DSS}}$         | $V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=0\text{V}$  |      |       | -1        | $\mu\text{A}$    |
| Gate-Body Leakage Current             | $I_{\text{GSS}}$         | $V_{\text{GS}}=\pm 10\text{V}, V_{\text{DS}}=0\text{V}$   |      |       | $\pm 100$ | nA               |
| Gate Threshold Voltage                | $V_{\text{GS(th)}}$      | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$   | -0.4 | -0.62 | -1.0      | V                |
| Static Drain-Source On-Resistance     | $R_{\text{DS(ON)}}$      | $V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-5.4\text{A}$   |      | 23    | 34        | $\text{m}\Omega$ |
|                                       |                          | $V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-4\text{A}$   |      | 31    | 44        |                  |
|                                       |                          | $V_{\text{GS}}=-1.8\text{V}, I_{\text{D}}=-3\text{A}$   |      | 44    | 62        |                  |
| Diode Forward Voltage                 | $V_{\text{SD}}$          | $I_{\text{S}}=-5.4\text{A}, V_{\text{GS}}=0\text{V}$  |      |       | -1.2      | V                |
| Maximum Body-Diode Continuous Current | $I_{\text{S}}$           |   |      |       | -5.6      | A                |
| <b>Dynamic Parameters</b>             |                          |   |      |       |           |                  |
| Input Capacitance                     | $C_{\text{iss}}$         | $V_{\text{DS}}=-9\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$  |      | 1010  |           | $\text{pF}$      |
| Output Capacitance                    | $C_{\text{oss}}$         |   |      | 135   |           |                  |
| Reverse Transfer Capacitance          | $C_{\text{rss}}$         |   |      | 109   |           |                  |
| <b>Switching Parameters</b>           |                          |   |      |       |           |                  |
| Total Gate Charge                     | $Q_{\text{g}}$           | $V_{\text{GS}}=-4.5\text{V}, V_{\text{DS}}=-9\text{V}, I_{\text{D}}=-5.6\text{A}$                             |      | 11.0  |           | $\text{nC}$      |
| Gate-Source Charge                    | $Q_{\text{gs}}$          |   |      | 2.2   |           |                  |
| Gate-Drain Charge                     | $Q_{\text{gd}}$          |   |      | 2.5   |           |                  |
| Reverse Recovery Charge               | $Q_{\text{rr}}$          | $I_{\text{f}}=-4\text{A}, \frac{dI}{dt}=100\text{A/us}$   |      | 4.4   |           | $\text{ns}$      |
| Reverse Recovery Time                 | $t_{\text{rr}}$          |   |      | 25    |           |                  |
| Turn-on Delay Time                    | $t_{\text{D(on)}}$       |   |      | 8     |           |                  |
| Turn-on Rise Time                     | $t_{\text{r}}$           | $V_{\text{GS}}=-4.5\text{V}, V_{\text{DS}}=-9\text{V}, I_{\text{D}}=-1\text{A}$<br>$R_{\text{GEN}}=2.5\Omega$ |      | 36    |           | $\text{ns}$      |
| Turn-off Delay Time                   | $t_{\text{D(off)}}$      |   |      | 77    |           |                  |
| Turn-off fall Time                    | $t_{\text{f}}$           |   |      | 56    |           |                  |

A. Pulse Test: Pulse Width  $\leq 300\text{us}$ , Duty cycle  $\leq 2\%$ .B.  $R_{\text{GJA}}$  is the sum of the junction-to-lead and lead-to-ambient thermal resistance, where the lead thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\text{GJL}}$  is guaranteed by design, while  $R_{\text{GJA}}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

## ■ Typical Performance Characteristics

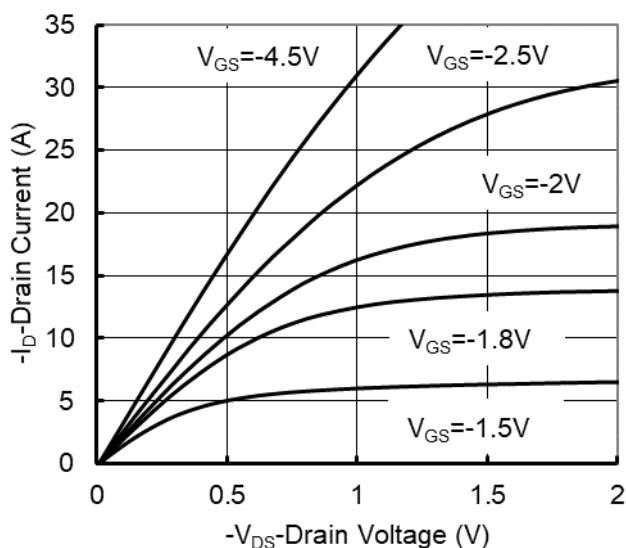


Figure 1. Output Characteristics

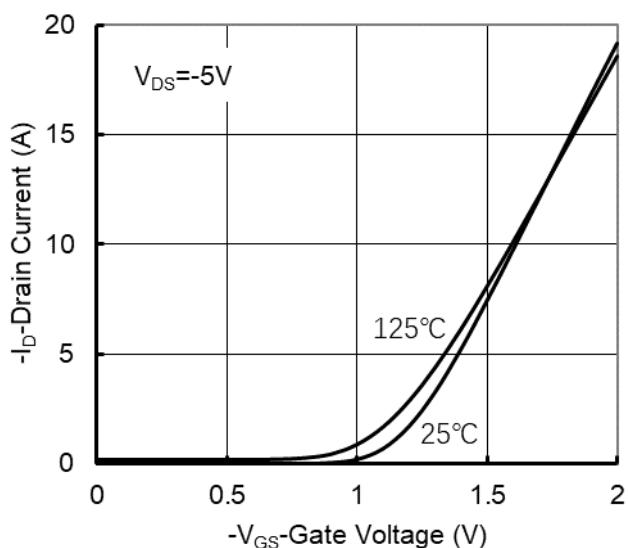


Figure 2. Transfer Characteristics

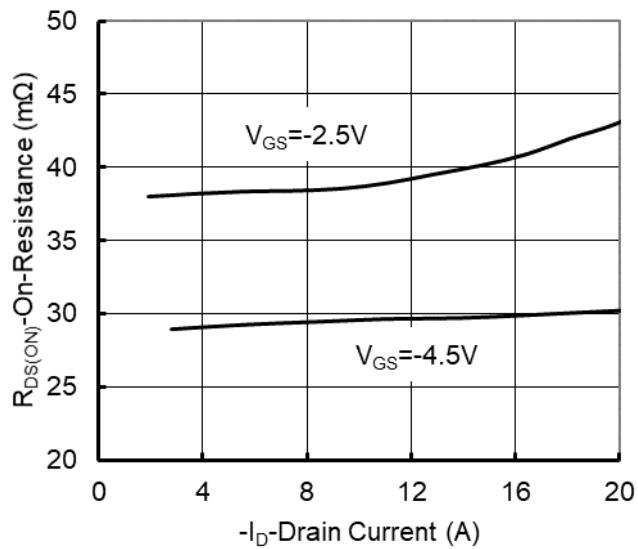


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

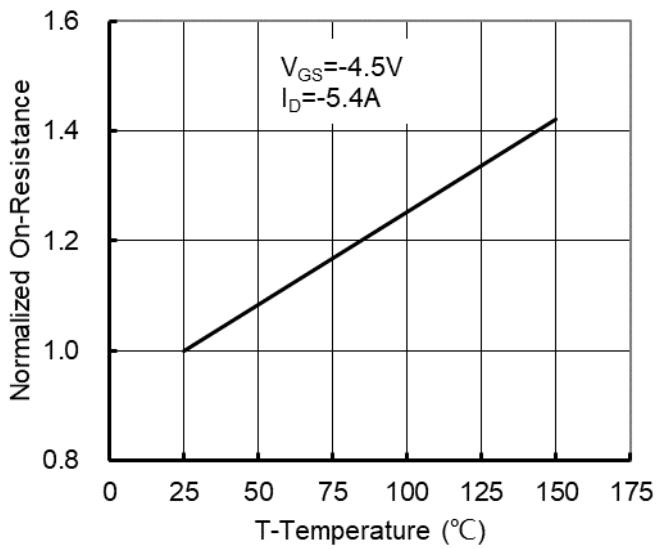


Figure 4: On-Resistance vs. Junction Temperature

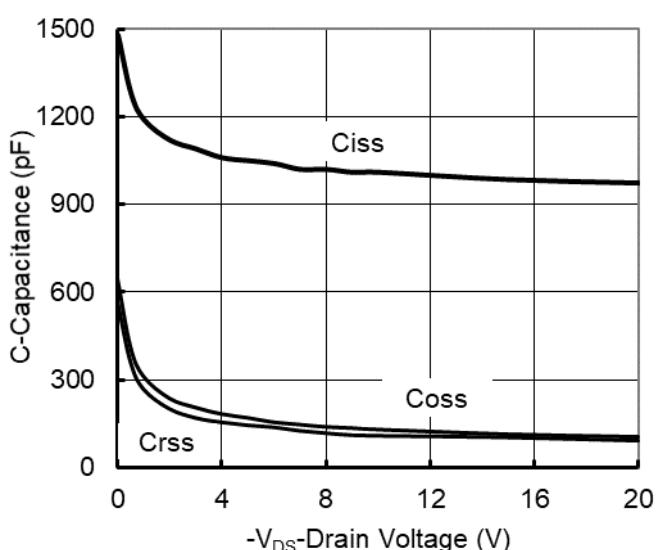


Figure 5. Capacitance Characteristics

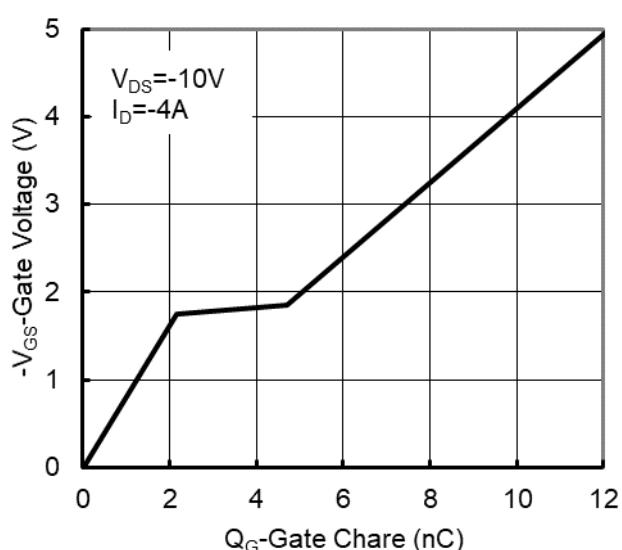


Figure 6. Gate Charge

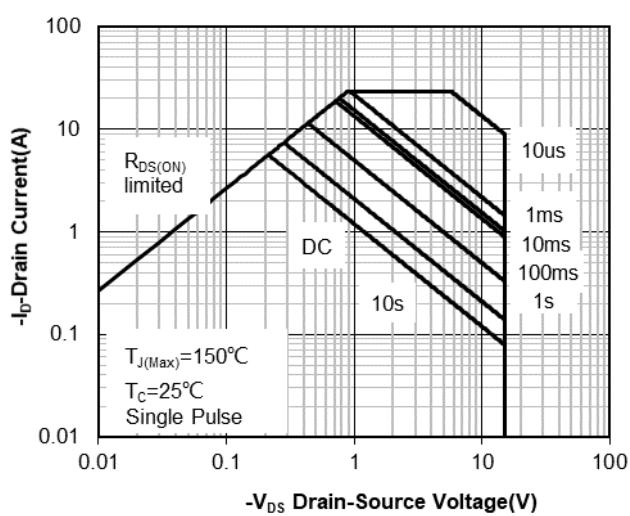


Figure 7. Safe Operation Area

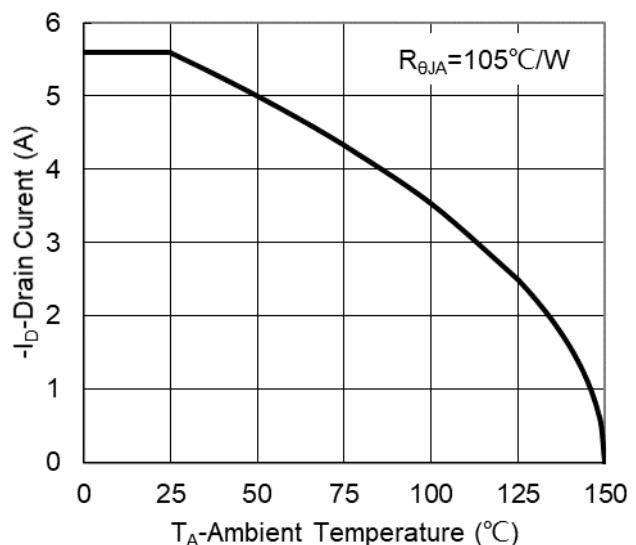


Figure 8. Maximum Continuous Drain Current vs Ambient Temperature

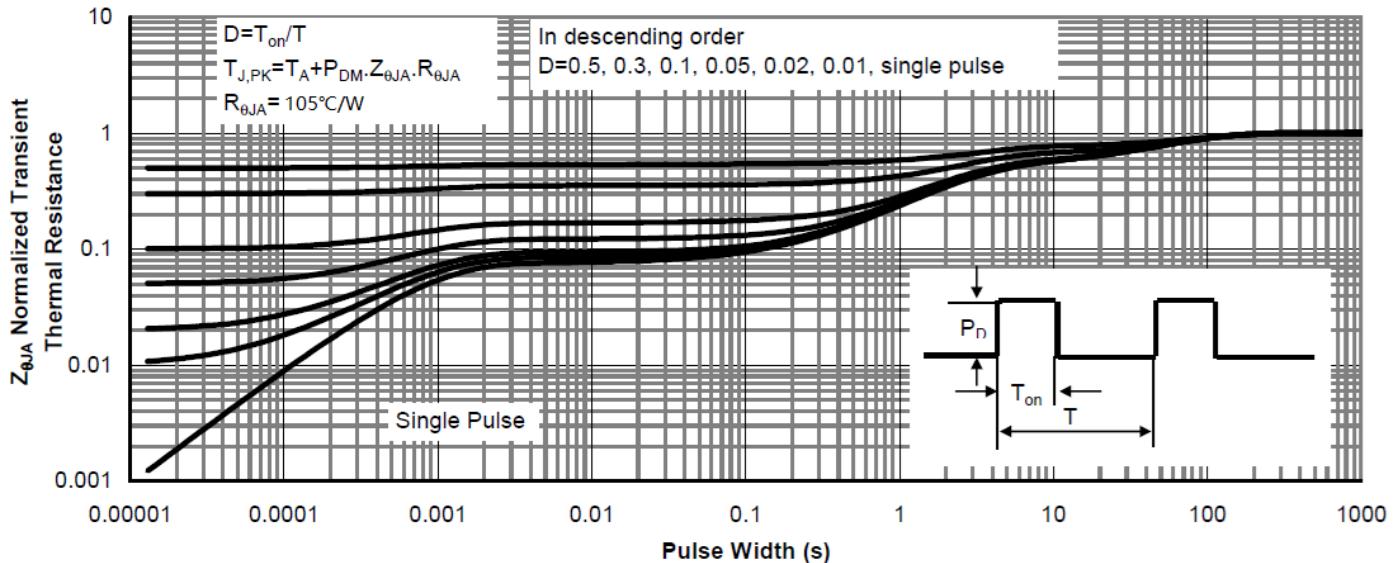
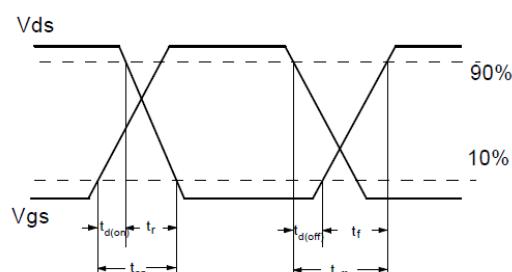
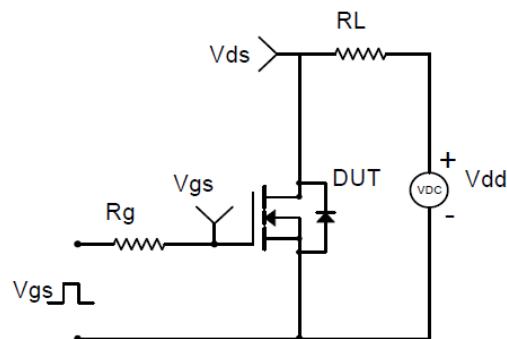
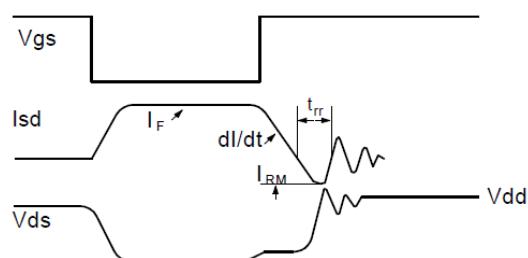
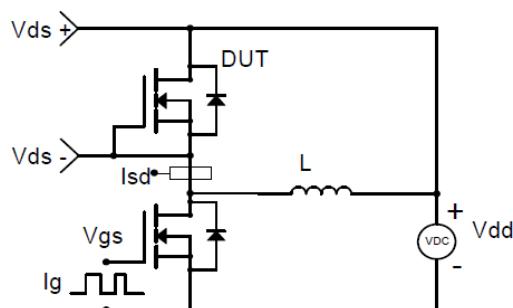


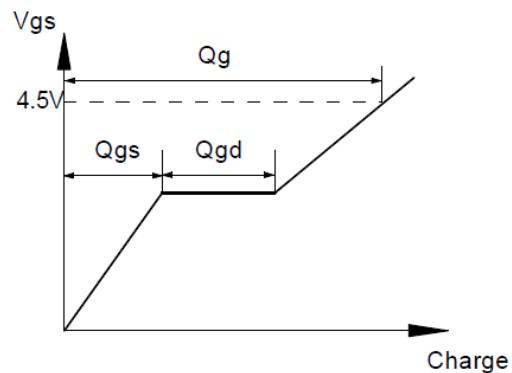
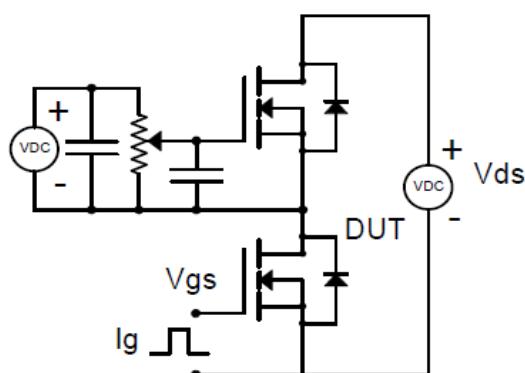
Figure 9. Normalized Maximum Transient Thermal Impedance



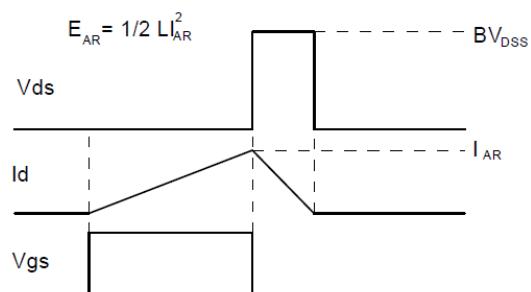
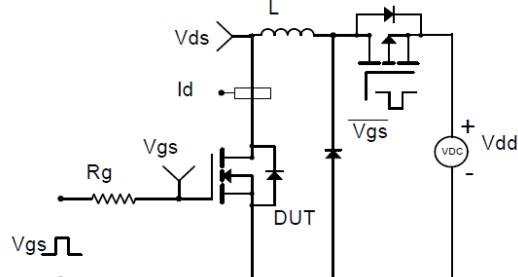
Resistive Switching Test Circuit &amp; Waveforms



Diode Recovery Test Circuit &amp; Waveforms

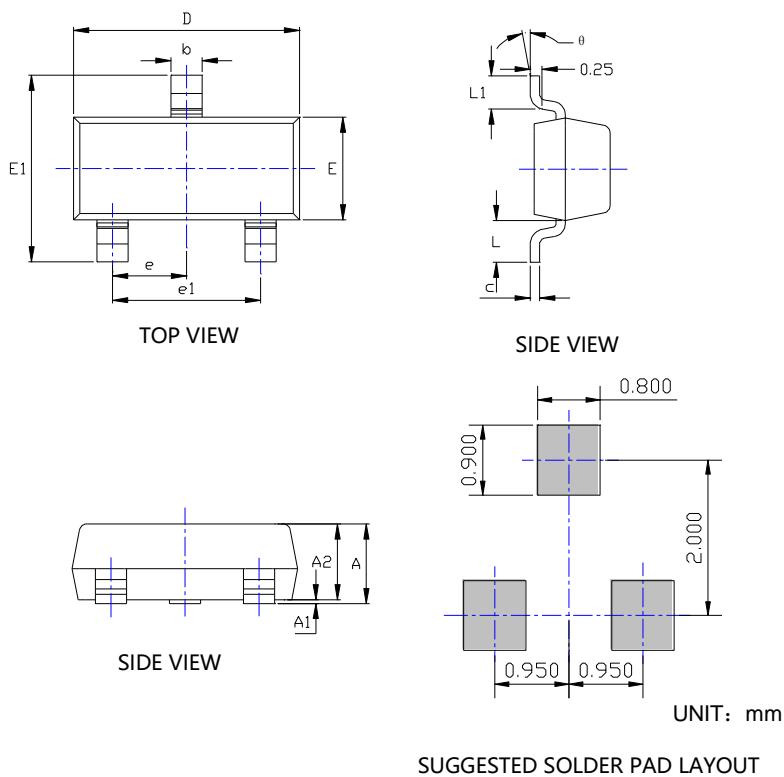


Gate Charge Test Circuit &amp; Waveform



Unclamped Inductive Switching (UIS) Test Circuit &amp; Waveforms

## ■ SOT-23 Package Information



| SYMBOL | INCHES   |       | Millimeter |       |
|--------|----------|-------|------------|-------|
|        | MIN.     | MAX.  | MIN.       | MAX.  |
| A      | 0.035    | 0.045 | 0.900      | 1.150 |
| A1     | 0.000    | 0.004 | 0.000      | 0.100 |
| A2     | 0.035    | 0.041 | 0.900      | 1.050 |
| b      | 0.012    | 0.020 | 0.300      | 0.500 |
| c      | 0.004    | 0.008 | 0.100      | 0.200 |
| D      | 0.110    | 0.118 | 2.800      | 3.000 |
| E      | 0.047    | 0.055 | 1.200      | 1.400 |
| E1     | 0.089    | 0.100 | 2.250      | 2.550 |
| e      | 0.037TYP |       | 0.950TYP   |       |
| e1     | 0.071    | 0.079 | 1.800      | 2.000 |
| L      | 0.022REF |       | 0.550REF   |       |
| L1     | 0.012    | 0.200 | 0.300      | 0.500 |
| θ      | 0°       | 8°    | 0°         | 8°    |

### NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.

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